



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 109-11-3.
- 0.00381 MIN MATTE TIN LEAD PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- 0.00381 MIN MATTE TIN PLATE OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.

MATERIAL	FINISH	MATERIAL	COLOR	PART NO.
BRASS, TIN	4	HIGH TEMP NYLON, UL94V-2	BLACK	6-794065-0
BRASS, TIN	4	HIGH TEMP NYLON, UL94V-0	BLACK	5-794065-0
BRASS, GOLD	5	NYLON, UL94V-0	WHITE	1-794065-1
BRASS, TIN	4	NYLON, UL94V-0	WHITE	1-794065-0
BRASS, GOLD	3	NYLON, UL94V-0	WHITE	794065-2
BRASS, TIN-LEAD	2	NYLON, UL94V-0	WHITE	794065-1

PIN		HOUSING		
THIS DRAWING IS A CONTROLLED DOCUMENT.		TE Connectivity		
DIMENSIONS: mm		DRAWING NO. A100779C=794065		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		SCALE 8:1 SHEET 1 OF 1 REV E1		
0 PLC	± -	CUSTOMER DRAWING		
1 PLC	± -			
2 PLC	± 0.13			
3 PLC	± -			
4 PLC	± -			
ANGLES	± -			